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| FORM PTO-1449 | Docket No.: 1433.232.101/14.019 | Serial No.: Unknown Priority Appln. No. DE 103 55 561.7 Int'l Appln. No. PCT/2004/002601 |
| LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT | Applicant: Recai Sezi et al. | |
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| | Filing Date: Herewith Priority Date 28 November 2003 Int'l Filing Date 24 November 2004 | Group Art: |

U.S. PATENT DOCUMENTS

| Examiner Initial | Document No. | Date | Name | Class | Sub Class | Filing Date If Appropriate |
|------------------|--------------|---------|-----------------|-------|-----------|----------------------------|
| | 4,371,883 | 2/1983 | Potember et al. | | | |
| | 4,652,894 | 3/1987 | Potember et al. | | | |
| | 4,806,995 | 2/1989 | Day et al. | | | |
| | 4,871,236 | 10/1989 | Gemma et al. | | | |
| | 5,161,149 | 11/1992 | Potember et al. | | | |
| | 2003/0001178 | 1/2003 | Hsu et al. | | | |
| | 2004/0108514 | 6/2004 | Tanaka et al. | | | |
| | | | | | | |
| | | | | | | |

FOREIGN PATENT DOCUMENTS

| Document No. | Date | Country | Class | Sub Class | Translated Yes No |
|---------------|---------|---------|-------|-----------|---------------------|
| JP 2003283004 | 10/2003 | EPO | | | Yes (Abstract Only) |
| | | | | | Yes |
| | | | | | Yes |

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

| | |
|--|--|
| | Sezi, R. et al., "Organic Materials for High-Density Non-Volatile Memory Applications," IEEE, IEDM 03-259, pp. 10.2.1-10.2.4 (2003). |
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EXAMINER: /Colleen Snow/

DATE CONSIDERED: 04/14/2010

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.